



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Michael B. Ball

Serial No.: 09/943,880

Filed: August 30, 2001

For: METHOD OF FABRICATION OF STACKED SEMICONDUCTOR DEVICES

Confirmation No.: 2391

Examiner: A. Chambliss

Group Art Unit: 2827

Attorney Docket No.: 2269-2769.6US

(95-1118.04/US)

Notice of Allowance Mailed:

December 31, 2003

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1460.

March 16, 2004

Date

Signature

Deidra J. Pfeil

Name (Type/Print)

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Mail Stop ISSUE FEE Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 10 of this paper.

Remarks begin on page 13 of this paper.